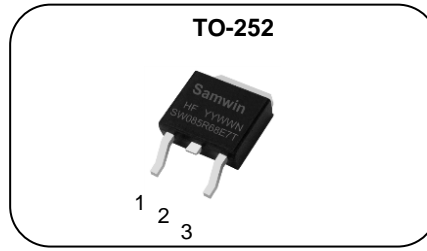


### N-channel Enhanced mode TO-252 MOSFET

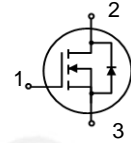
#### Features

- High ruggedness
- Low  $R_{DS(ON)}$  (Typ 10.2m $\Omega$ )@ $V_{GS}=10V$
- Low Gate Charge (Typ 47nC)
- Improved dv/dt Capability
- 100% Avalanche Tested
- Application: Synchronous Rectification, Li Battery Protect Board, Inverter



1. Gate 2. Drain 3. Source

$BV_{DSS}$  : 68V  
 $I_D$  : 70A  
 $R_{DS(ON)}$  : 10.2m $\Omega$



#### General Description

This power MOSFET is produced with advanced technology of SAMWIN. This technology enable the power MOSFET to have better characteristics, including fast switching time, low on resistance, low gate charge and especially excellent avalanche characteristics.



#### Order Codes

Item	Sales Type	Marking	Package	Packaging
1	SW D 085R68E7T	SW085R68E7T	TO-252	REEL

#### Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{DSS}$	Drain to source voltage	68	V
$I_D$	Continuous drain current (@ $T_C=25^\circ C$ )	70*	A
	Continuous drain current (@ $T_C=100^\circ C$ )	45*	A
$I_{DM}$	Drain current pulsed (note 1)	280	A
$V_{GS}$	Gate to source voltage	$\pm 20$	V
$E_{AS}$	Single pulsed avalanche energy (note 2)	180	mJ
$E_{AR}$	Repetitive avalanche energy (note 1)	18	mJ
dv/dt	Peak diode recovery dv/dt (note 3)	5	V/ns
$P_D$	Total power dissipation (@ $T_C=25^\circ C$ )	92.6	W
	Derating factor above 25 $^\circ C$	0.74	W/ $^\circ C$
$T_{STG}, T_J$	Operating junction temperature & storage temperature	-55 ~ + 150	$^\circ C$

\*. Drain current is limited by junction temperature.

#### Thermal characteristics

Symbol	Parameter	Value	Unit
$R_{thjc}$	Thermal resistance, Junction to case	1.35	$^\circ C/W$

## Electrical characteristic ( $T_J = 25^\circ\text{C}$ unless otherwise specified )

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
<b>Off characteristics</b>						
$BV_{DSS}$	Drain to source breakdown voltage	$V_{GS}=0V, I_D=250\mu A$	68			V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown voltage temperature coefficient	$I_D=250\mu A$ , referenced to $25^\circ\text{C}$		0.04		$V/^\circ\text{C}$
$I_{DSS}$	Drain to source leakage current	$V_{DS}=68V, V_{GS}=0V$			1	$\mu A$
		$V_{DS}=54V, T_J=125^\circ\text{C}$			50	$\mu A$
$I_{GSS}$	Gate to source leakage current, forward	$V_{GS}=20V, V_{DS}=0V$			100	nA
	Gate to source leakage current, reverse	$V_{GS}=-20V, V_{DS}=0V$			-100	nA
<b>On characteristics</b>						
$V_{GS(TH)}$	Gate threshold voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2		4	V
$R_{DS(ON)}$	Drain to source on state resistance	$V_{GS}=10V, I_D=40A, T_J=25^\circ\text{C}$		10.2	12.5	$m\Omega$
		$V_{GS}=10V, I_D=40A, T_J=125^\circ\text{C}$		16.2		$m\Omega$
$G_{fs}$	Forward transconductance	$V_{DS}=5V, I_D=40A$		61		S
<b>Dynamic characteristics</b>						
$C_{iss}$	Input capacitance	$V_{GS}=0V, V_{DS}=34V, f=1\text{MHz}$		2145		pF
$C_{oss}$	Output capacitance			163		
$C_{rss}$	Reverse transfer capacitance			129		
$t_{d(on)}$	Turn on delay time	$V_{DS}=34V, I_D=30A, R_G=4.7\Omega, V_{GS}=10V$ (note 4,5)		13		ns
$t_r$	Rising time			40		
$t_{d(off)}$	Turn off delay time			35		
$t_f$	Fall time			15		
$Q_g$	Total gate charge	$V_{DS}=54V, V_{GS}=10V, I_D=30A, I_G=5\text{mA}$ (note 4,5)		47		nC
$Q_{gs}$	Gate-source charge			14		
$Q_{gd}$	Gate-drain charge			16		
$R_g$	Gate resistance	$V_{DS}=0V$ , Scan F mode		2.7		$\Omega$

## Source to drain diode ratings characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_S$	Continuous source current	Integral reverse p-n Junction diode in the MOSFET			70	A
$I_{SM}$	Pulsed source current				280	A
$V_{SD}$	Diode forward voltage drop.	$I_S=45A, V_{GS}=0V$			1.4	V
$t_{rr}$	Reverse recovery time	$I_S=30A, V_{GS}=0V,$		20		ns
$Q_{rr}$	Reverse recovery charge	$di_f/dt=100A/\mu s$		13		nC

### ※. Notes

1. Repeattive rating : pulse width limited by junction temperature.
2.  $L=0.5\text{mH}, I_{AS}=26.8A, V_{DD}=30V, R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$
3.  $I_{SD} \leq 30A, di/dt = 100A/\mu s, V_{DD} \leq BV_{DSS}$ , Starting  $T_J=25^\circ\text{C}$
4. Pulse Test : Pulse Width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
5. Essentially independent of operating temperature.

Fig. 1. On-state characteristics

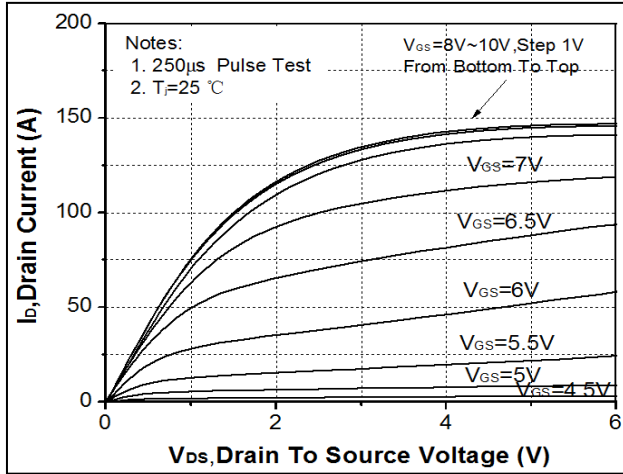


Fig. 2. Transfer Characteristics

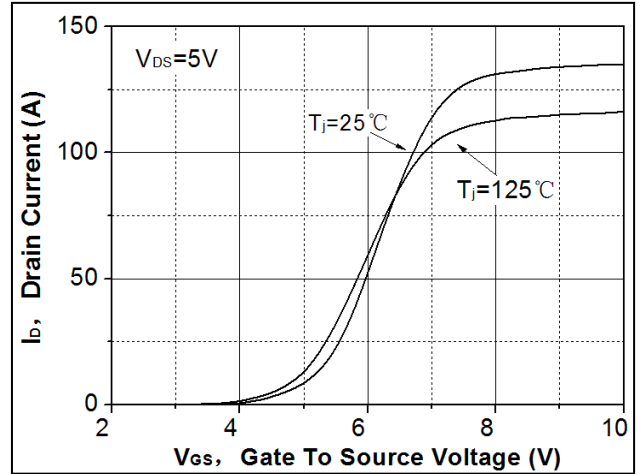


Fig. 3. On-resistance variation vs. drain current and gate voltage

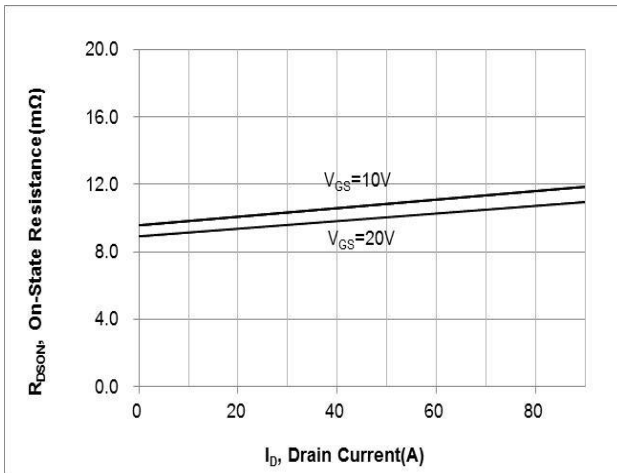


Fig. 4. On-state current vs. diode forward voltage

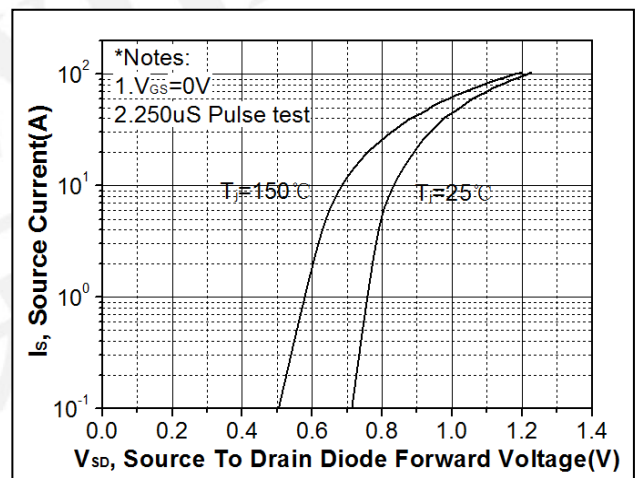


Fig 5. Breakdown voltage variation vs. junction temperature

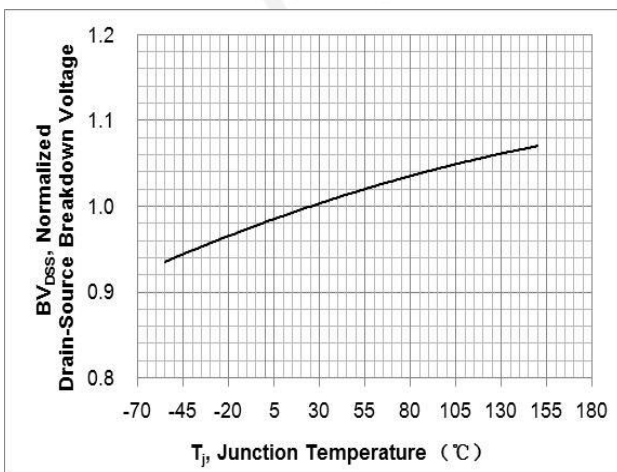


Fig. 6. On-resistance variation vs. junction temperature

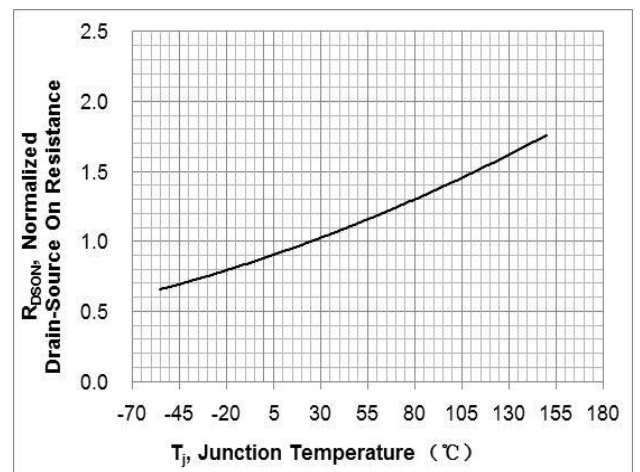


Fig. 7. Gate charge characteristics

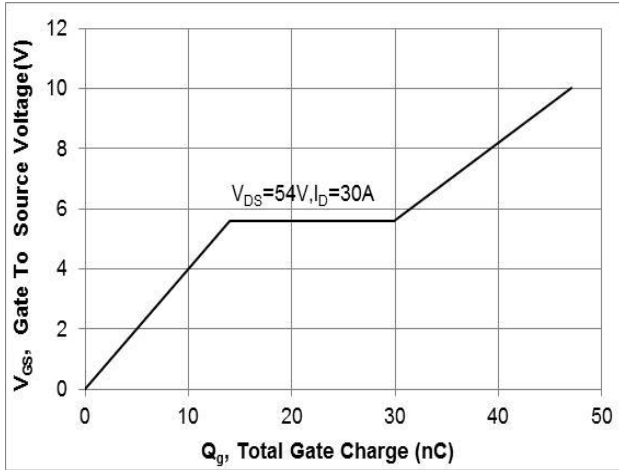


Fig. 8. Capacitance Characteristics

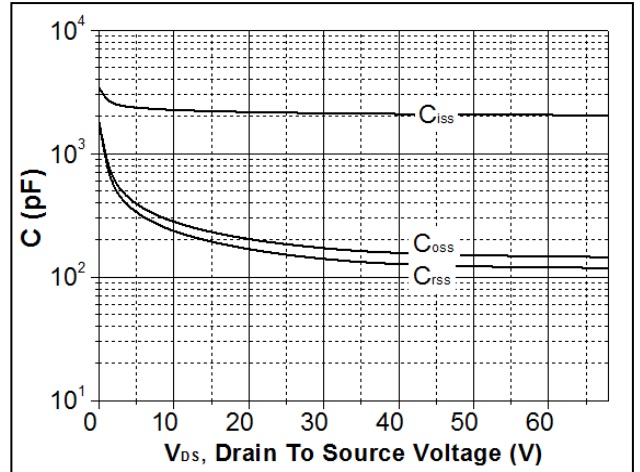


Fig. 9. Maximum safe operating area

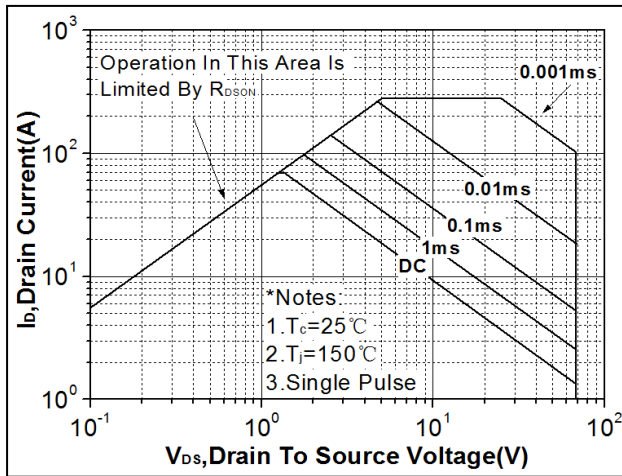


Fig. 10. Maximum drain current vs. case temperature

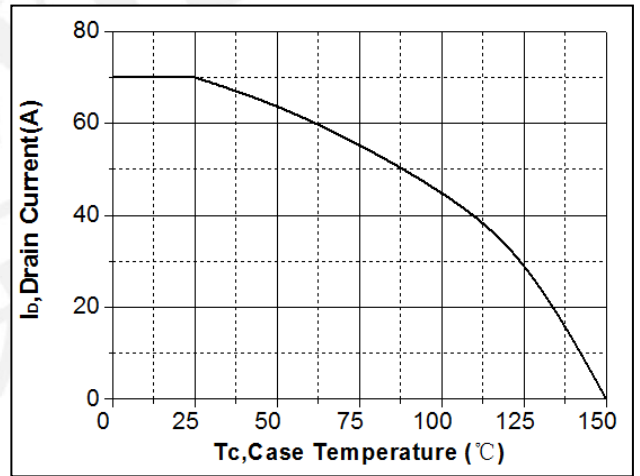


Fig. 11. Transient thermal response curve

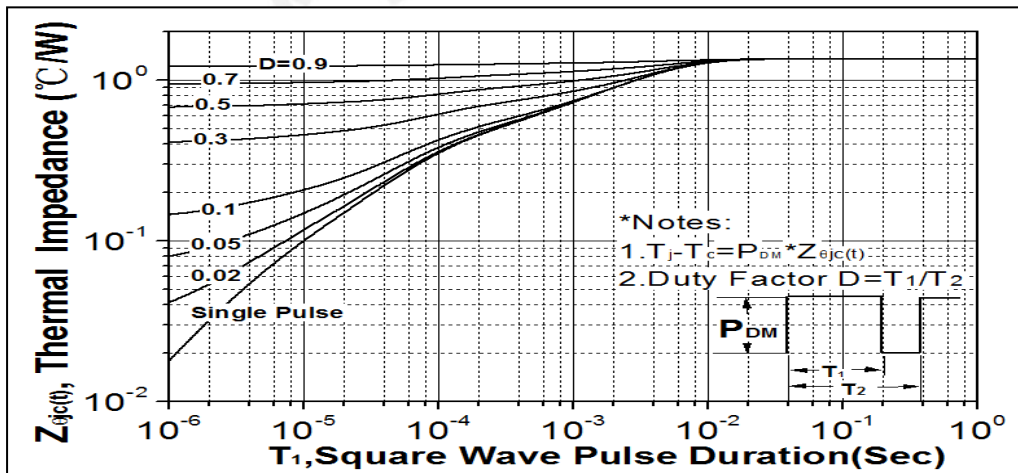


Fig. 12. Gate charge test circuit & waveform

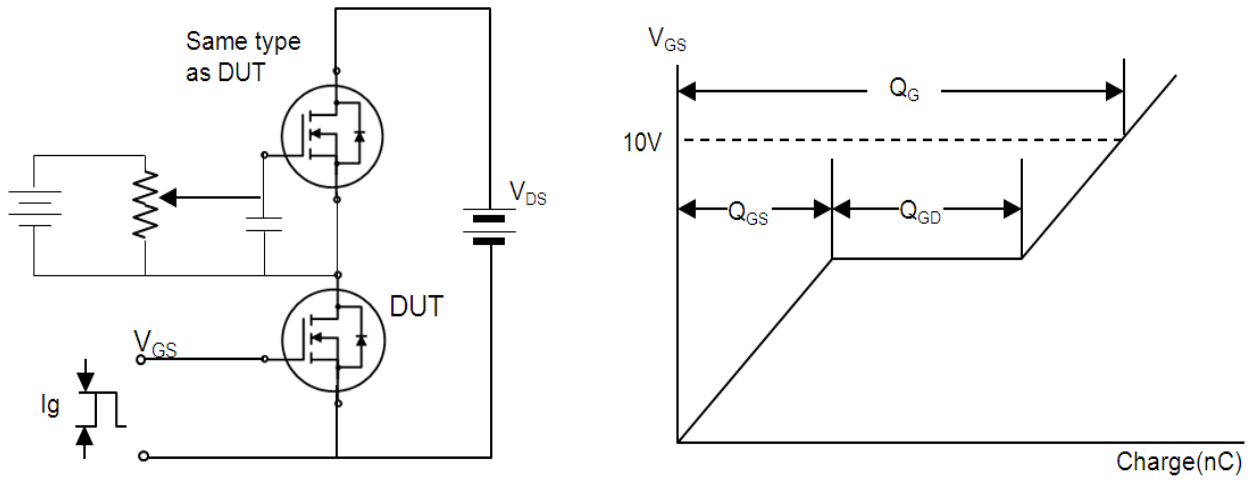


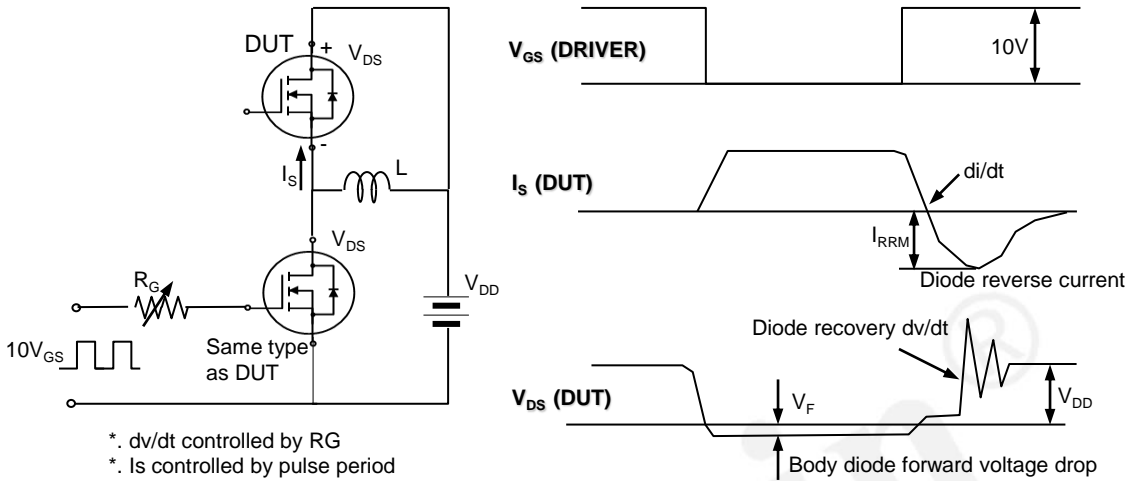
Fig. 13. Switching time test circuit & waveform



Fig. 14. Unclamped Inductive switching test circuit & waveform



Fig. 15. Peak diode recovery dv/dt test circuit & waveform



### DISCLAIMER

\* All the data & curve in this document was tested in SEMIPOWER TESTING & APPLICATION CENTER.

\* This product has passed the PCT,TC,HTRB,HTGB,HAST,PC and Solderdunk reliability testing.

\* Qualification standards can also be found on the Web site (<http://www.semipower.com.cn>) 

\* Suggestions for improvement are appreciated, Please send your suggestions to [samwin@samwinsemi.com](mailto:samwin@samwinsemi.com)

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